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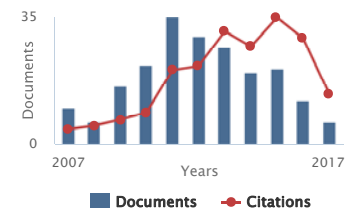Other name formats: Lim, S. K.
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